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(12) **United States Design Patent**
Kirkendall et al.

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(54) **MODULAR POD**

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(US)

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(**) Term: **14 Years**

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(51) **LOC (10) Cl.** **14-02**

(52) **U.S. Cl.**
USPC **D14/432**

(58) **Field of Classification Search**

USPC D14/300, 301, 308, 312, 432, 433, 439,
D14/441–446, 299; 361/695, 679.48, 679.5,
361/679.51, 690, 727; 415/213.1, 214.1,
415/184; 165/185, 80.3; 312/223.3
CPC G06Q 20/18; G06Q 20/10; G06Q 20/123;
G06Q 20/20; G06Q 30/02; G06Q 30/06;
A47F 9/047

See application file for complete search history.

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(57) **CLAIM**

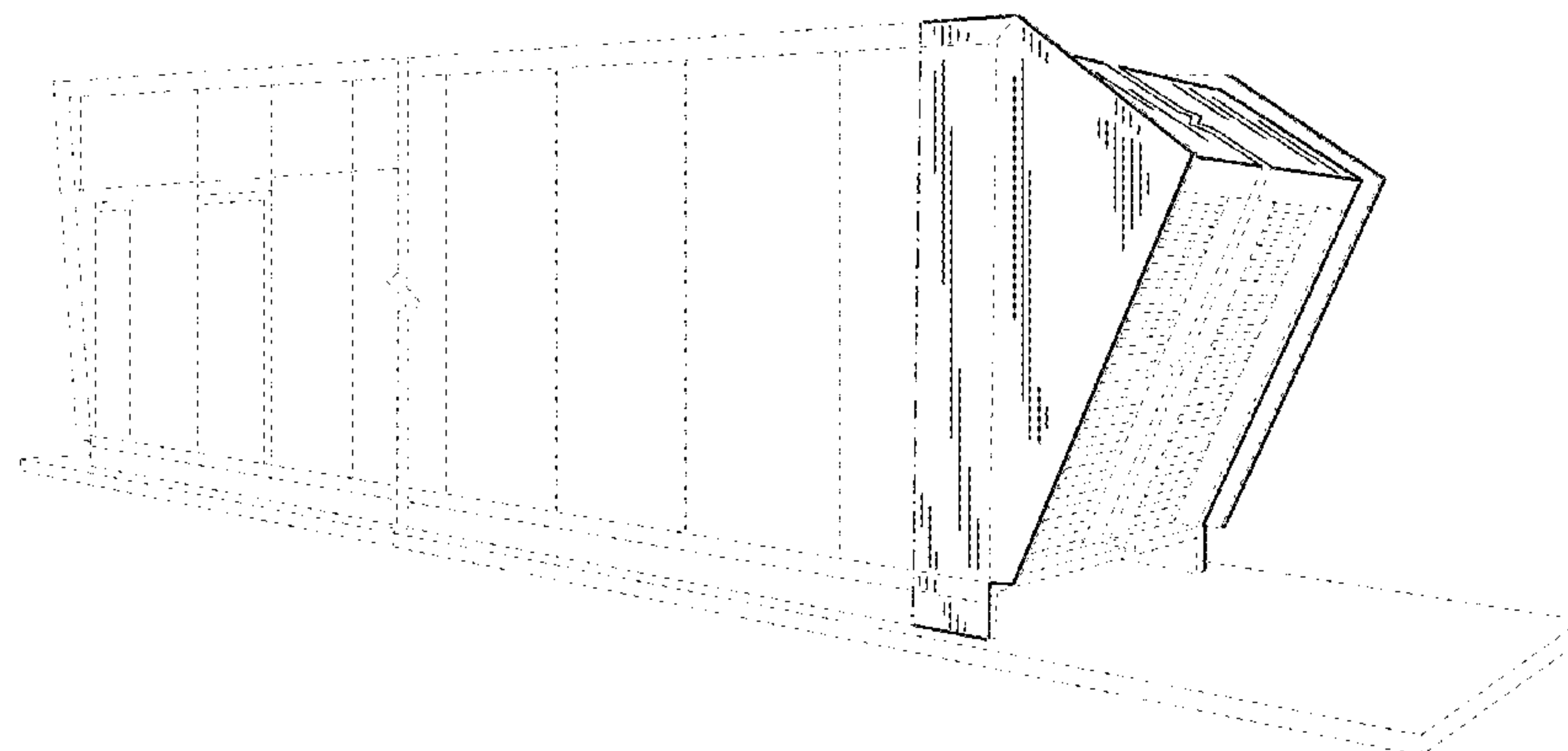
The ornamental design for a modular pod, as shown and
described.

DESCRIPTION

FIG. 1 shows a front perspective view of a modular pod;
FIG. 2 shows a left elevation view of the modular pod of FIG.
1;
FIG. 3 shows a right elevation view of the modular pod of
FIG. 1;
FIG. 4 shows a top view of the modular pod of FIG. 1;
FIG. 5 shows a front elevation view of the modular pod of
FIG. 1; and,
FIG. 6 shows a rear elevation view of the modular pod of FIG.
1.

The dashed lines illustrate the environment and the bound-
aries of the modular pod. None of the dashed lines forms any
part of the claimed design. The dot-dash lines illustrate
unclaimed boundaries between the claimed design and the
unclaimed design. The break lines illustrate that no portion of
the design is claimed between adjacent break lines.

1 Claim, 3 Drawing Sheets



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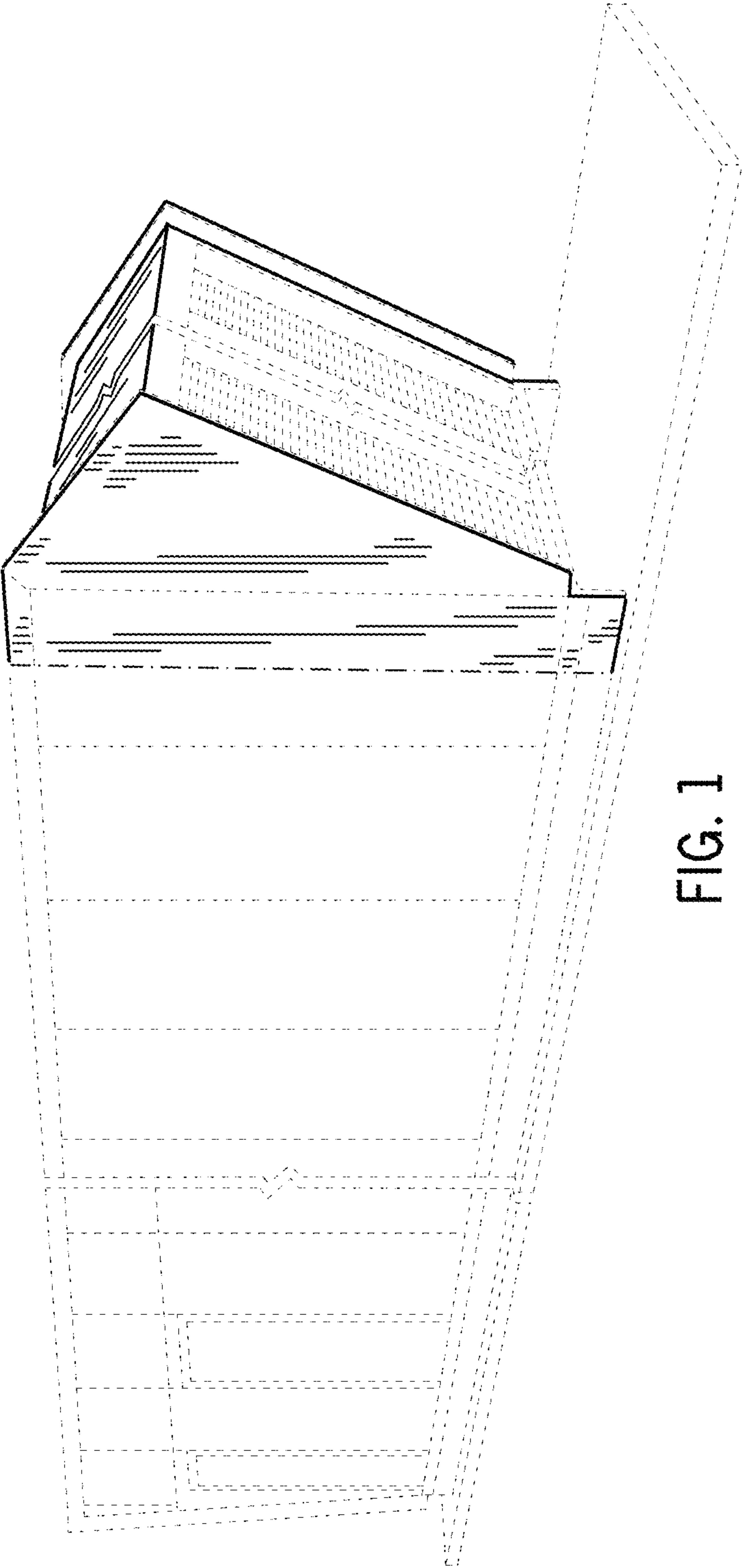
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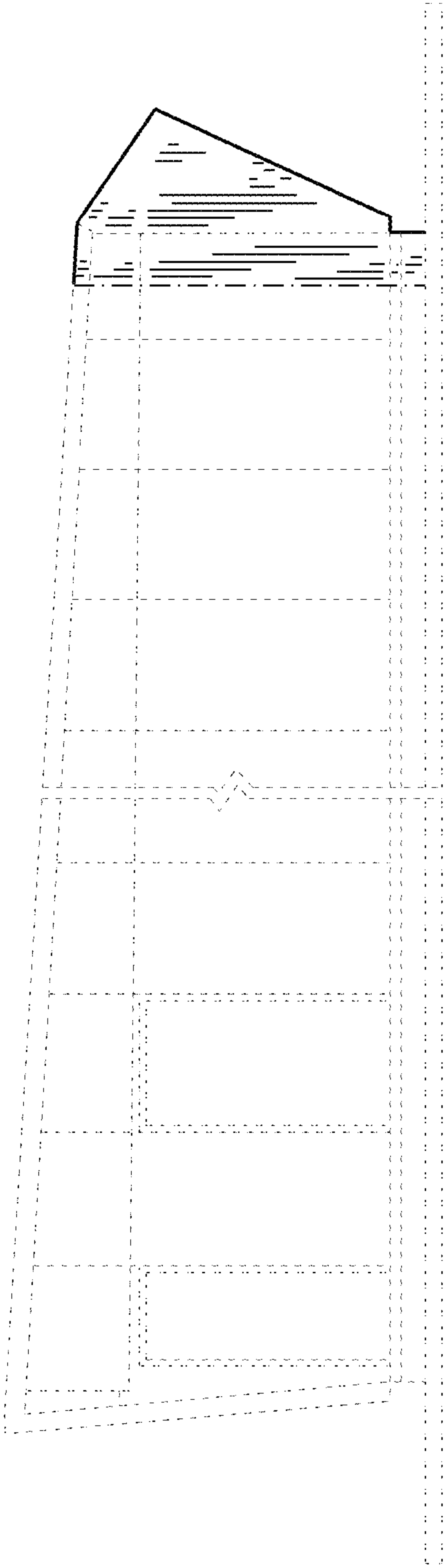


FIG. 2

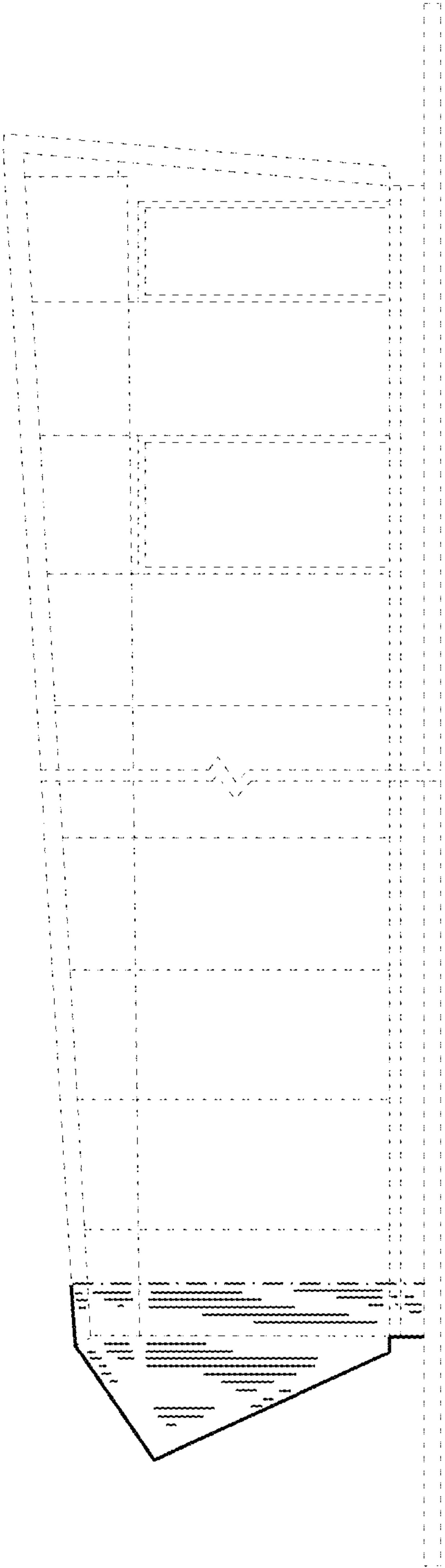


FIG. 3

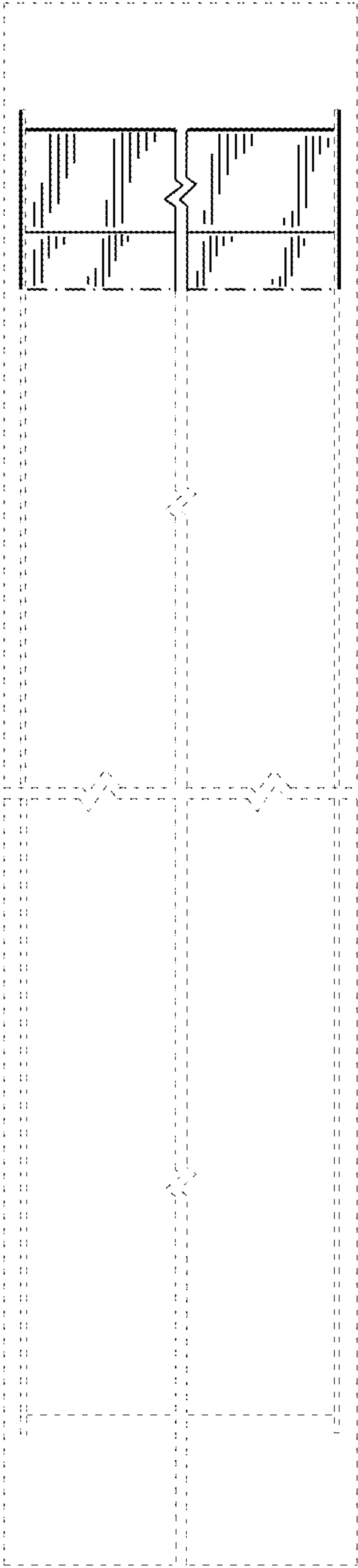


FIG. 4

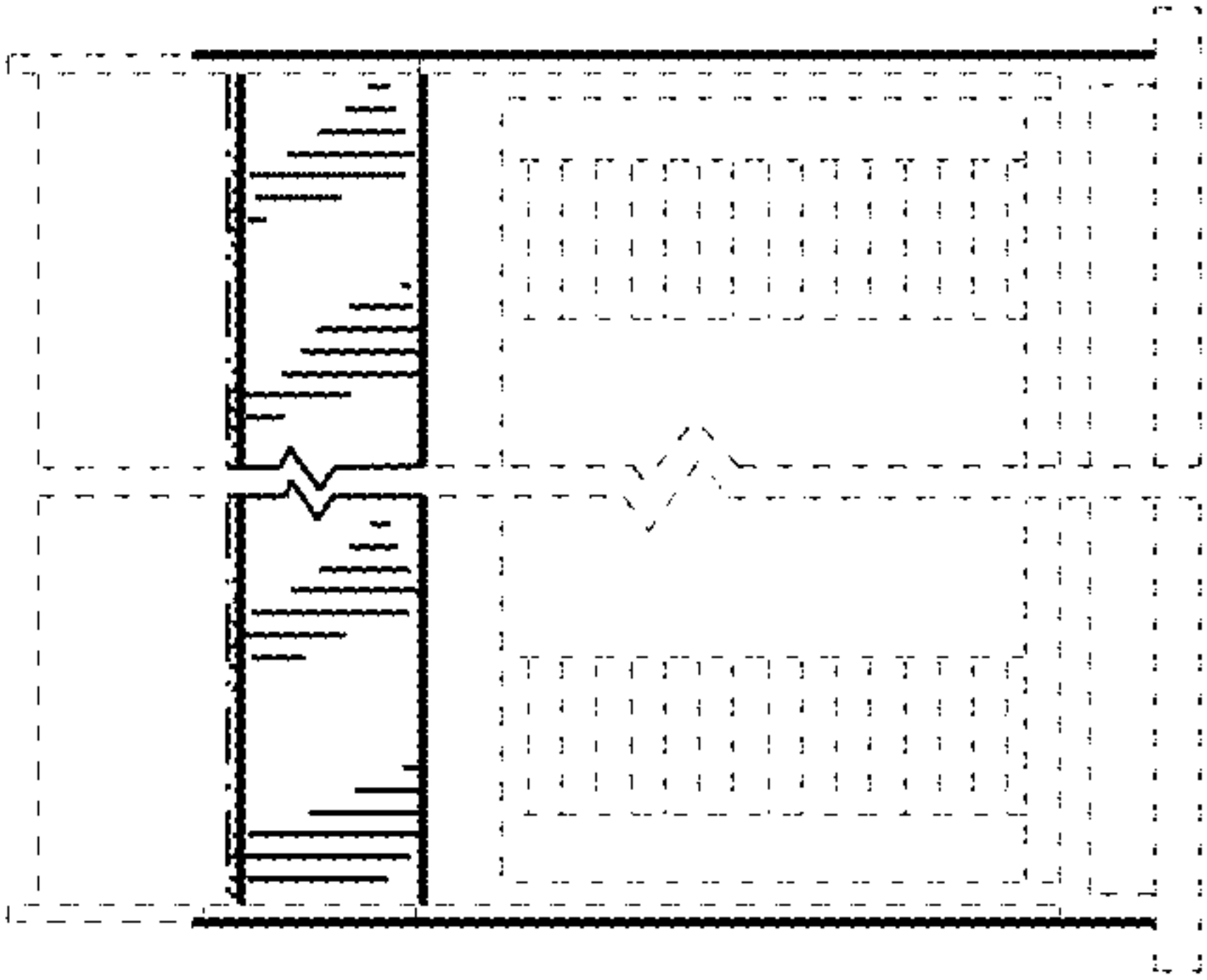


FIG. 5

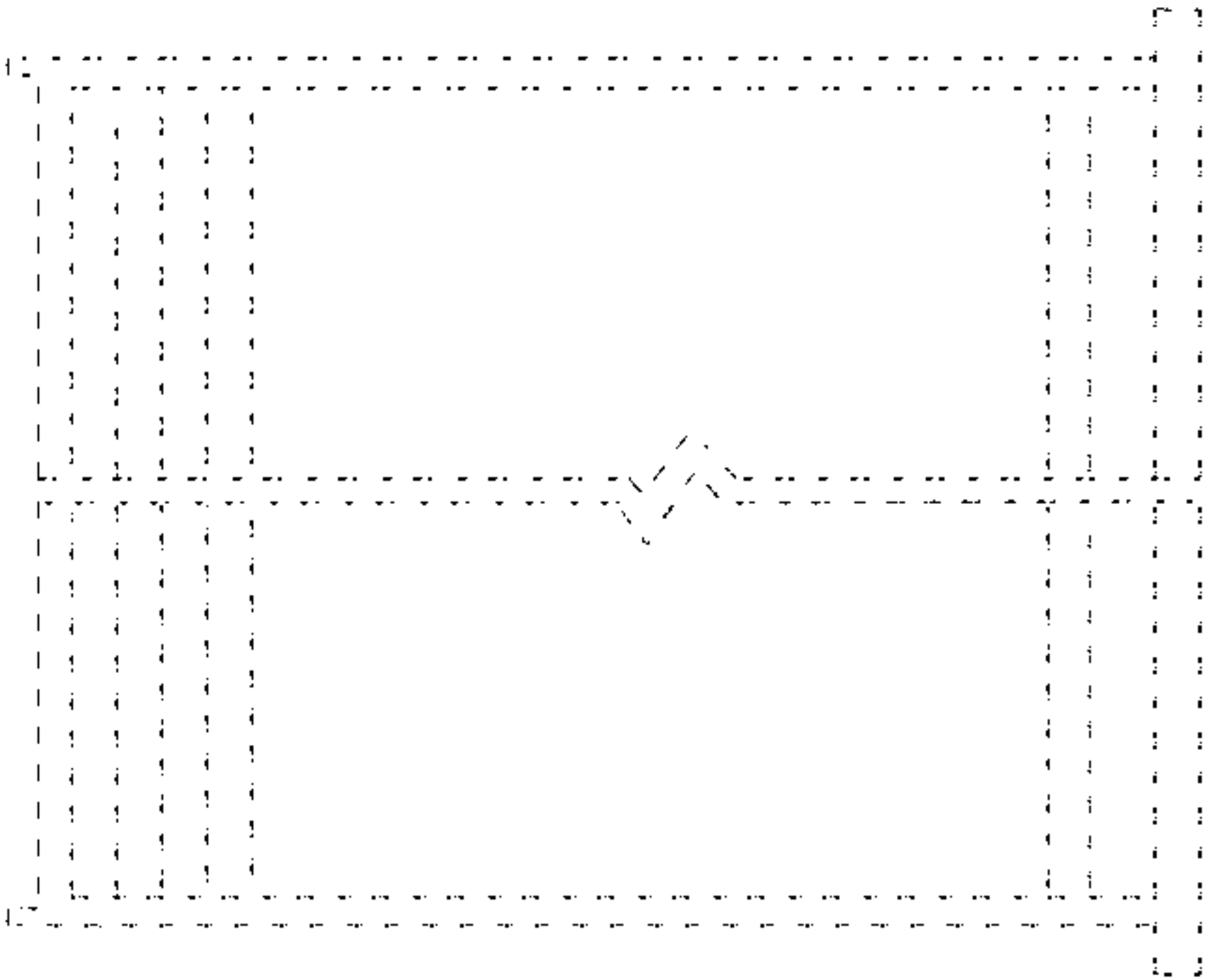


FIG. 6